### Advanced elemental analysis of semiconductors and microelectronics using QUANTAX WDS for SEM



Bruker Nano Analytics, Berlin, Germany Webinar, July 16, 2020



![](_page_1_Picture_0.jpeg)

![](_page_1_Picture_1.jpeg)

### **Are There Any Questions?**

Please type in the questions you might have in the Q&A box and press *Send*.

#### Presenters

![](_page_2_Picture_1.jpeg)

![](_page_2_Picture_2.jpeg)

Dr. Michael Abratis

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![](_page_2_Picture_5.jpeg)

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Applications Specialist microXRF, Bruker Nano Analytics, Berlin, Germany

# Introduction Samples

![](_page_3_Picture_1.jpeg)

#### Semiconductors

- MoS<sub>2</sub>
- WSi<sub>2</sub>
- TaSi<sub>2</sub>
- (Ag)PbTe Bi

![](_page_3_Picture_7.jpeg)

#### Microelectronics

- Layered sample (W–Ta–Si)
- Semiconductor microchip (SSD/CPU)

![](_page_3_Picture_11.jpeg)

![](_page_4_Picture_0.jpeg)

![](_page_4_Picture_1.jpeg)

#### **Spectral overlaps in semiconductors**

- Peak overlaps common in semiconductors
- EDS applies peak deconvolution
- WDS able to resolve peaks
- WDS requires no post-processing
- WDS can achieve higher precision in element identification

#### Small structures in semiconductors and microelectronics

- High spatial resolution required
- Low voltage application required
- High spectral resolution at low energies required

![](_page_5_Picture_0.jpeg)

![](_page_5_Picture_1.jpeg)

- Introduction to QUANTAX WDS
- What is a Semiconductor and what is it good for?
- Application on Semiconductors
- Application on Microelectronics
- Workflow for QUANTAX WDS analyses
- Summary and Conclusion

### QUANTAX WDS System Components

#### QUANTAX WDS: integral part of the QUANTAX family

![](_page_6_Picture_3.jpeg)

- Spectrum, P/B-acquisition in 'Spectrum' and 'Objects' mode
- Mapping and LineScan
- Quantification (SB, coupled quant possible)
- Device control
- ... all integrated in the Esprit GUI

#### **ESPRIT 2**

![](_page_6_Figure_10.jpeg)

![](_page_6_Figure_11.jpeg)

![](_page_6_Picture_12.jpeg)

![](_page_6_Picture_13.jpeg)

![](_page_6_Picture_14.jpeg)

### XSense WD Spectrometer Setup and Working Principle

![](_page_7_Picture_1.jpeg)

![](_page_7_Figure_2.jpeg)

Bragg equation:  $n\lambda = 2d \sin(\theta)$ 

#### Spectrometer comparison Advantages of WDS over EDS

![](_page_8_Picture_1.jpeg)

![](_page_8_Picture_2.jpeg)

Compared with EDS the WDS shows:

- substantially higher spectral resolution (typically 3 15 eV FWHM)
- enhanced P/B-ratios, i.e. lower detection limits
- outstanding sensitivity for light elements including Be, B

## WDS is an ideal technique to complement EDS in demanding applications

#### Semiconductors What is a Semiconductor

![](_page_9_Picture_1.jpeg)

"A **semiconductor** material has an electrical conductivity value falling between that of a conductor, such as metallic copper, and an insulator, such as glass." (Wikipedia)

This is described by the **band structure**. It describes the energetic position of the **valence band**, where tightly bound valence electrons are situated, and the **conduction band**, where electrons can potentially hop from one atom to another, and thus contribute to carrying a current, with respect to the **Fermi-level**.

![](_page_9_Figure_4.jpeg)

In a **conductor** those bands are in contact or overlap, there are always mobile electrons available.

![](_page_9_Figure_6.jpeg)

#### In a **semiconductor**

those bands are in proximity, electrons can be excited from the valence into the conduction band.

![](_page_9_Figure_9.jpeg)

In an **insulator** there is a "large" band gap (> 6 eV), preventing electrons from becoming 'mobilized'.

#### Semiconductors What does a Semiconductor do

![](_page_10_Picture_1.jpeg)

![](_page_10_Figure_2.jpeg)

The Fermi-level ( $E_F$ ) describes the energy at which there is a 50 % probability of a virtual state to be occupied at the given conditions and at thermal equilibrium.

The probability of this occupation can be described by Fermi–Dirac distribution:

$$ar{n}_i = rac{1}{e^{(arepsilon_i - \mu)/k_{ ext{B}}T} + 1}$$

The Fermi level  $\mu$  (also  $E_F$ ) can be manipulated locally by introducing additional charges by incorporation of donor and acceptor states through doping.

Also the number of available charge carriers depends on the temperature and other excitation sources, allowing for a multitude of different applications.

#### Fermi-Dirac distribution

![](_page_10_Figure_9.jpeg)

#### Semiconductors What is it good for?

- Resulting from the temperature dependency of the conductivity, it allows for construction of thermocouples of high sensitivity in certain temperature ranges.
- As charge carriers can be generated by absorption of light of sufficient photon energy, they are used for photodetectors.
- In semiconductors with a suitable band structure • (mostly direct band gap), the reverse effect as well is possible, they can emit light through the recombination of a hole (in valence band) and an electron (from conduction band).
- Combining different semiconductors or differently doped areas of semiconductors allows for building diodes (only allowing current in one direction) and transistors, to control a current, and build efficient and fast amplifiers.

![](_page_11_Picture_6.jpeg)

0.3/20 10<sup>5</sup>

10

10

10

Resistance (  $\Omega$ )

![](_page_11_Figure_7.jpeg)

![](_page_11_Picture_8.jpeg)

![](_page_11_Figure_9.jpeg)

![](_page_11_Picture_10.jpeg)

100

![](_page_12_Picture_1.jpeg)

![](_page_12_Picture_2.jpeg)

Image dimensions: 1.4 x 1.1 mm

![](_page_13_Picture_1.jpeg)

![](_page_13_Figure_2.jpeg)

![](_page_14_Picture_1.jpeg)

![](_page_14_Figure_2.jpeg)

or measured pure element peaks

![](_page_14_Figure_4.jpeg)

10

0

2,60

**S-K**β1

0

2,15

2,20 2,25

2,30

2,35

2,40

Energy [keV]

Mo-LB

2,45 2,50 2,55

![](_page_15_Picture_1.jpeg)

![](_page_15_Figure_2.jpeg)

![](_page_16_Picture_1.jpeg)

![](_page_16_Picture_2.jpeg)

Image dimensions: 724 x 538 µm

![](_page_17_Picture_1.jpeg)

![](_page_17_Figure_2.jpeg)

![](_page_18_Picture_1.jpeg)

![](_page_18_Figure_2.jpeg)

### Application 2 Tungsten silicide (WSi<sub>2</sub>) mapping

![](_page_19_Picture_1.jpeg)

![](_page_19_Picture_2.jpeg)

#### Image dimensions: 72 x 54 $\mu$ m

#### Testing for sample homogeneity

![](_page_20_Picture_1.jpeg)

Si

![](_page_20_Figure_3.jpeg)

![](_page_20_Figure_4.jpeg)

EDS

![](_page_20_Picture_5.jpeg)

![](_page_20_Picture_6.jpeg)

Si+W

#### BSE+ Si+W

![](_page_20_Picture_8.jpeg)

![](_page_21_Picture_1.jpeg)

Si

![](_page_21_Picture_3.jpeg)

![](_page_21_Picture_4.jpeg)

W

![](_page_21_Picture_5.jpeg)

Si+W

#### BSE+ Si+W

![](_page_21_Picture_7.jpeg)

![](_page_21_Picture_8.jpeg)

![](_page_21_Picture_9.jpeg)

![](_page_21_Picture_10.jpeg)

![](_page_21_Picture_11.jpeg)

![](_page_21_Picture_12.jpeg)

![](_page_22_Picture_1.jpeg)

Si

![](_page_22_Picture_3.jpeg)

![](_page_22_Picture_4.jpeg)

![](_page_22_Picture_5.jpeg)

W

![](_page_22_Picture_6.jpeg)

![](_page_22_Picture_7.jpeg)

BSE+ Si+W

![](_page_22_Picture_9.jpeg)

![](_page_22_Picture_10.jpeg)

WDS

![](_page_22_Picture_11.jpeg)

![](_page_22_Picture_12.jpeg)

![](_page_22_Picture_13.jpeg)

![](_page_22_Picture_14.jpeg)

![](_page_22_Picture_15.jpeg)

![](_page_22_Picture_16.jpeg)

![](_page_22_Picture_17.jpeg)

![](_page_22_Picture_18.jpeg)

![](_page_23_Picture_1.jpeg)

Si

![](_page_23_Picture_3.jpeg)

![](_page_23_Picture_4.jpeg)

![](_page_23_Picture_5.jpeg)

![](_page_23_Picture_6.jpeg)

Si+W

BSE+ Si+W

![](_page_23_Picture_8.jpeg)

![](_page_23_Picture_9.jpeg)

WDS

![](_page_23_Picture_10.jpeg)

![](_page_23_Picture_11.jpeg)

![](_page_23_Picture_12.jpeg)

![](_page_23_Picture_13.jpeg)

![](_page_23_Picture_14.jpeg)

![](_page_23_Picture_15.jpeg)

![](_page_23_Picture_16.jpeg)

![](_page_23_Picture_17.jpeg)

![](_page_24_Picture_1.jpeg)

![](_page_24_Picture_2.jpeg)

Image dimensions: 724 x 538 µm

![](_page_25_Picture_1.jpeg)

![](_page_25_Figure_2.jpeg)

### Application 3 Tantalum silicide (TaSi<sub>2</sub>) single grain

![](_page_26_Picture_1.jpeg)

![](_page_26_Figure_2.jpeg)

#### Image dimensions: 32 x 24 $\mu$ m

#### Testing for sample homogeneity

![](_page_27_Picture_1.jpeg)

Si

![](_page_27_Picture_3.jpeg)

EDS

![](_page_27_Picture_4.jpeg)

Та

![](_page_27_Picture_5.jpeg)

![](_page_27_Picture_6.jpeg)

BSE

![](_page_28_Picture_1.jpeg)

Si

![](_page_28_Picture_3.jpeg)

![](_page_28_Picture_4.jpeg)

![](_page_28_Picture_5.jpeg)

![](_page_28_Picture_6.jpeg)

![](_page_28_Picture_7.jpeg)

![](_page_28_Picture_8.jpeg)

![](_page_28_Picture_9.jpeg)

![](_page_28_Picture_10.jpeg)

![](_page_28_Picture_11.jpeg)

![](_page_29_Picture_1.jpeg)

Si

![](_page_29_Picture_3.jpeg)

![](_page_29_Picture_4.jpeg)

Si+Ta

![](_page_29_Picture_6.jpeg)

BSE

![](_page_29_Picture_8.jpeg)

![](_page_29_Picture_9.jpeg)

EDS

![](_page_29_Picture_10.jpeg)

![](_page_29_Picture_11.jpeg)

![](_page_29_Picture_12.jpeg)

![](_page_29_Picture_13.jpeg)

![](_page_29_Picture_14.jpeg)

![](_page_29_Picture_15.jpeg)

WDS

![](_page_29_Picture_17.jpeg)

![](_page_29_Picture_18.jpeg)

![](_page_29_Picture_19.jpeg)

![](_page_30_Picture_1.jpeg)

![](_page_30_Picture_2.jpeg)

### Application 4 Silver-doped lead telluride - (Ag)PbTe

![](_page_31_Picture_1.jpeg)

![](_page_31_Figure_2.jpeg)

Image dimensions: 1.4 x 1.1 mm

### Application 4 (Ag)PbTe mapped by EDS

![](_page_32_Picture_1.jpeg)

![](_page_32_Picture_2.jpeg)

![](_page_32_Picture_3.jpeg)

![](_page_32_Figure_4.jpeg)

6% area remain undetermined

#### Map sum spectrum

#### Application 4 EDS interactive deconvolution

![](_page_33_Picture_1.jpeg)

![](_page_33_Figure_2.jpeg)

![](_page_33_Figure_3.jpeg)

#### Maximum pixel spectrum

![](_page_33_Figure_5.jpeg)

![](_page_33_Figure_6.jpeg)

### Application 4 (Ag)PbTe – Bi resolved by WDS

![](_page_34_Picture_1.jpeg)

![](_page_34_Figure_2.jpeg)

### Acceleration voltage Effect on spatial/depth resolution

![](_page_35_Picture_1.jpeg)

 Monte Carlo electron-trajectory simulations of interaction volume in layered sulphides as function of primary beam energy

![](_page_35_Figure_3.jpeg)

Casino v.2.5.1

With higher primary electron energy penetration depth is increasing and spatial resolution of the analysis is decreasing

### Application 5 Layered structure in microelectronics

![](_page_36_Picture_1.jpeg)

![](_page_36_Picture_2.jpeg)

Image dimensions: 1.5 x 1.1 mm

### Application 5 Layered structure in microelectronics

![](_page_37_Picture_1.jpeg)

![](_page_37_Figure_2.jpeg)

#### Application 5 Layered microelectronics @10kV

![](_page_38_Picture_1.jpeg)

![](_page_38_Figure_2.jpeg)

#### Application 5 Layered microelectronics @10kV

![](_page_39_Picture_1.jpeg)

![](_page_39_Figure_2.jpeg)

#### Application 5 Layered microelectronics @10kV

![](_page_40_Picture_1.jpeg)

![](_page_40_Figure_2.jpeg)

#### Application 6 Semiconductor microchip

![](_page_41_Picture_1.jpeg)

![](_page_41_Figure_2.jpeg)

Image dimensions: 4.3 x 3.2 mm

### Application 6 Semiconductor microchip (MOSFET)

![](_page_42_Picture_1.jpeg)

![](_page_42_Figure_2.jpeg)

#### EDS w/ deconvolution

![](_page_42_Figure_4.jpeg)

#### WDS reveals more details

#### Video Workflow for WDS analyses

![](_page_43_Picture_1.jpeg)

![](_page_43_Figure_2.jpeg)

Summary and Conclusions QUANTAX WDS Benefits

![](_page_44_Picture_1.jpeg)

#### **High spectral resolution**

- Significant increase in spectral resolution
- Pathological EDS peak overlaps can be resolved
- Improved analytical information

#### High lateral and depth resolution

- Enables X-ray analysis at low kV
- Eneases X-ray analysis on the nano-scale
- Allows analysis of sub-µm structures
- Allows analysis of sub-µm layers

![](_page_45_Picture_0.jpeg)

![](_page_45_Picture_1.jpeg)

### **Are There Any Questions?**

Please type in the questions you might have in the Q&A box and press *Send*.

![](_page_46_Picture_0.jpeg)

#### Innovation with Integrity